

Global HBM Thermal Compression Bonding Equipment Supply, Demand and Key Producers, 2026-2032

<https://marketpublishers.com/r/G482DE45D8D2EN.html>

Date: July 2026

Pages: 124

Price: US\$ 4,480.00 (Single User License)

ID: G482DE45D8D2EN

Abstracts

The global HBM Thermal Compression Bonding Equipment market size is expected to reach \$ 4567 million by 2032, rising at a market growth of 24.0% CAGR during the forecast period (2026-2032).

In 2025, global HBM Thermal Compression Bonding Equipment production reached approximately 306 units, with an average global market price of around USD 3,200,000 per unit.

The gross profit margin of major companies in the industry is between 32.48%?56.72%.

In 2025, the global production capacity of HBM Thermal Compression Bonding Equipment was approximately 403 units.

HBM Thermal Compression Bonding Equipment is advanced semiconductor packaging equipment used to bond stacked high-bandwidth memory dies through controlled heat, pressure and alignment. It supports fine-pitch micro-bump bonding, hybrid bonding preparation or thermocompression processes required for high-density memory stacks and advanced AI chips. The equipment requires high placement accuracy, temperature uniformity, force control, clean process environment and high throughput. The market includes thermocompression bonders and related bonding systems for HBM packaging, but excludes general wire bonders, flip-chip bonders for standard packages and finished HBM products.

The industry chain includes precision stages, bonding heads, heaters, force sensors, vision systems, alignment modules, vacuum chucks, control software, cleanroom

components and metrology tools. Midstream production covers mechanical design, thermal control, motion calibration, vision alignment, software integration, process qualification, reliability testing and installation services. Downstream demand comes from advanced packaging lines, memory packaging, AI chip production, foundry packaging services and outsourced assembly facilities. Growth is driven by HBM capacity expansion, AI accelerator demand, advanced packaging adoption and finer interconnect requirements.

This report studies the global HBM Thermal Compression Bonding Equipment production, demand, key manufacturers, and key regions.

This report is a detailed and comprehensive analysis of the world market for HBM Thermal Compression Bonding Equipment and provides market size (US\$ million) and Year-over-Year (YoY) Growth, considering 2025 as the base year. This report explores demand trends and competition, as well as details the characteristics of HBM Thermal Compression Bonding Equipment that contribute to its increasing demand across many markets.

Highlights and key features of the study

Global HBM Thermal Compression Bonding Equipment total production and demand, 2021-2032, (Units)

Global HBM Thermal Compression Bonding Equipment total production value, 2021-2032, (USD Million)

Global HBM Thermal Compression Bonding Equipment production by region & country, production, value, CAGR, 2021-2032, (USD Million) & (Units), (based on production site)

Global HBM Thermal Compression Bonding Equipment consumption by region & country, CAGR, 2021-2032 & (Units)

U.S. VS China: HBM Thermal Compression Bonding Equipment domestic production, consumption, key domestic manufacturers and share

Global HBM Thermal Compression Bonding Equipment production by manufacturer, production, price, value and market share 2021-2026, (USD Million) & (Units)

Global HBM Thermal Compression Bonding Equipment production by Type, production, value, CAGR, 2021-2032, (USD Million) & (Units)

Global HBM Thermal Compression Bonding Equipment production by Application, production, value, CAGR, 2021-2032, (USD Million) & (Units)

This report profiles key players in the global HBM Thermal Compression Bonding Equipment market based on the following parameters - company overview, production,

value, price, gross margin, product portfolio, geographical presence, and key developments. Key companies covered as a part of this study include HANMI Semiconductor, ASMPT, Besi, Kulicke & Soffa Industries, Hanwha Semitech, SEMES, Toray Engineering, Shibaura Mechatronics, Yamaha Robotics, PrecisoNext Intelligent Technology, etc.

This report also provides key insights about market drivers, restraints, opportunities, new product launches or approvals.

Stakeholders would have ease in decision-making through various strategy matrices used in analyzing the World HBM Thermal Compression Bonding Equipment market

Detailed Segmentation:

Each section contains quantitative market data including market by value (US\$ Millions), volume (production, consumption) & (Units) and average price (K US\$/Unit) by manufacturer, by Type, and by Application. Data is given for the years 2021-2032 by year with 2025 as the base year, 2026 as the estimate year, and 2027-2032 as the forecast year.

Global HBM Thermal Compression Bonding Equipment Market, By Region:

United States

China

Europe

Japan

South Korea

ASEAN

India

Rest of World

Global HBM Thermal Compression Bonding Equipment Market, Segmentation by Type:

Chip-to-Wafer TCB Equipment

Chip-to-Substrate TCB Equipment

Die-to-Die TCB Equipment

Global HBM Thermal Compression Bonding Equipment Market, Segmentation by Equipment Configuration:

Single-Head TCB Equipment

Multi-Head TCB Equipment

Cluster TCB Equipment

Global HBM Thermal Compression Bonding Equipment Market, Segmentation by Placement Accuracy:

Standard Accuracy??3 ?m?

High Accuracy??1.5 ?m?

Ultra-High Accuracy???1 ?m?

Global HBM Thermal Compression Bonding Equipment Market, Segmentation by Application:

HBM Packaging

2.5D Advanced Packaging

3D IC Packaging

Other

Companies Profiled:

HANMI Semiconductor

ASMPT

Besi

Kulicke & Soffa Industries

Hanwha Semitech

SEMES

Toray Engineering

Shibaura Mechatronics

Yamaha Robotics

PrecisioNext Intelligent Technology

Micraft System Plus

Suzhou Maxwell Technologies

Key Questions Answered:

1. How big is the global HBM Thermal Compression Bonding Equipment market?
2. What is the demand of the global HBM Thermal Compression Bonding Equipment market?
3. What is the year over year growth of the global HBM Thermal Compression Bonding Equipment market?
4. What is the production and production value of the global HBM Thermal Compression Bonding Equipment market?
5. Who are the key producers in the global HBM Thermal Compression Bonding Equipment market?

6. What are the growth factors driving the market demand?

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